

Date: - 27 Jun, 2005

Data Sheet Issue:-1

#### **Provisional Data**

## **Rectifier Diode**

# Types W3841V#300 to W3841V#340

Development Type No.: WX095V#340

### **Absolute Maximum Ratings**

|           | VOLTAGE RATINGS                               |   | MAXIMUM<br>LIMITS | UNITS |
|-----------|---|---|-------------------|-------|
| $V_{RRM}$ | Repetitive peak reverse voltage, (note 1)     | / | 3000-3400         | V     |
| $V_{RSM}$ | Non-repetitive peak reverse voltage, (note 1) |   | 3100-3500         | V     |

|                      | OTHER RATINGS  | MAXIMUM<br>LIMITS    | UNITS            |
|----------------------|--|----------------------|------------------|
| I <sub>F(AV)M</sub>  | Maximum average forward current, T <sub>sink</sub> =55°C, (note 2)   | 3841                 | Α                |
| I <sub>F(AV)M</sub>  | Maximum average forward current. T <sub>sink</sub> =100°C/(note 2)   | 2819                 | Α                |
| I <sub>F(AV)M</sub>  | Maximum average forward current. T <sub>sink</sub> +100°C, (note 3)  | 1732                 | Α                |
| I <sub>F(RMS)M</sub> | Nominal RMS forward current, T <sub>sink</sub> =25°C (note 2)  | 6952                 | Α                |
| I <sub>F(d.c.)</sub> | D.C. forward current, T <sub>sink</sub> =25°C, (note 4)  | 6033                 | Α                |
| I <sub>FSM</sub>     | Peak non-repetitive surge t <sub>p</sub> =10 ms, V <sub>rm</sub> =60%V <sub>RRM</sub> , (note 5)           | 39.8                 | kA               |
| I <sub>FSM2</sub>    | Peak non-repetitive surge t <sub>p</sub> =10ms, V <sub>rm</sub> ≤10V, (note 5)                             | 43.8                 | kA               |
| l <sup>2</sup> t     | I <sup>2</sup> t capacity for fusing t <sub>p</sub> =10ms, V <sub>rm</sub> =60%V <sub>RRM</sub> , (note 5) | 7.92×10 <sup>6</sup> | $A^2s$           |
| I <sup>2</sup> t     | I <sup>2</sup> t capacity for fusing t <sub>p</sub> =10ms, V <sub>m</sub> ≤10V, (note 5)                   | 9.59×10 <sup>6</sup> | A <sup>2</sup> s |
| T <sub>j op</sub>    | Operating temperature range  | -40 to +175          | °C               |
| T <sub>stg</sub>     | Storage temperature range  | -55 to +175          | °C               |

#### Notes:-

- 1) De-rating factor of 0.13% per % is applicable for T<sub>j</sub> below 25°C.
- 2) Double side cooled, single phase; 50Hz, 180° half-sinewave.
- 3) Single side cooled, single phase; 50Hz, 180° half-sinewave.
- 4) Double side cooled.
- 5) Half-sinewaye, 175°C T<sub>i</sub> initial.



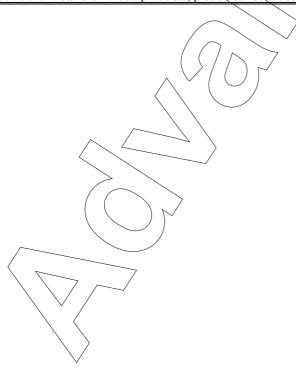
### **Characteristics**

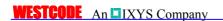
|                  | PARAMETER                                       | MIN. | TYP. | MAX.         | TEST CONDITIONS (Note 1)                                      | UNITS |
|------------------|---|------|------|--------------|---|-------|
| V                | Maximum peak forward voltage                    | -    | -    | 1.40         | I <sub>TM</sub> =4600A  | V     |
| V <sub>FM</sub>  | waximum peak forward voltage                    | -    | -    | 2.19         | I <sub>TM</sub> =11500A                                       | V     |
| $V_{T0}$         | Threshold voltage                               | -    | -    | 0.860        |   | ٧     |
| r <sub>T</sub>   | Slope resistance                                | -    | -    | 0.115        |   | mΩ    |
|                  | Dook roverse current                            | -    | -    | 20           | Rated V <sub>RRM</sub> , T <sub>j</sub> =25°C                 | mA    |
| I <sub>RRM</sub> | Peak reverse current                            | -    | -    | 100          | Rated V <sub>RRM</sub>  | mA    |
| Qrr              | Recovered charge                                | -    | 5200 | - /          |   | μC    |
| Q <sub>ra</sub>  | Recovered charge, 50% Chord                     | -    | 3700 | 4500         | / <sub>TM</sub> =1000A, t <sub>p</sub> =1000μs, di/dt=10A/μs, | μC    |
| Irr              | Reverse recovery current                        | -    | 200  |              | V <sub>r</sub> =50V   | Α     |
| t <sub>rr</sub>  | Reverse recovery time, 50% Chord                | -    | 37   | - \          |   | μs    |
| Б                | The arrest registers as it metion to be striply | -    | -    | 0.016        | Double side cooled  | K/W   |
| $R_{thJK}$       | Thermal resistance, junction to heatsink        | -    | -    | 0.032        | Single side cooled  | K/W   |
| F                | Mounting force                                  | 27   | - /  | 34           |   | kN    |
| 147              | Maiaht  | -    | 1000 | <u> </u>     | Outline Options VC & VT                                       | _     |
| Wt               | Weight  | -    | 800  | <b>/</b> / ) | Outline Option VF   | g     |

- 1) Unless otherwise indicated T<sub>i</sub>=175°C.
- 2) For other clamp forces, please consult factory.

Notes on rupture rated packages.

This product is available with a non-rupture rated package. For additional details on these products, please consult factory





#### **Notes on Ratings and Characteristics**

#### 1.0 Voltage Grade Table

| Voltage Grade | $egin{array}{c} V_{RRM} \ V \end{array}$ | V <sub>RSM</sub> V | V <sub>R</sub><br>DC V |
|---------------|--|--------------------|------------------------|
| 30            | 3000                                     | 3100               | 1750                   |
| 32            | 3200                                     | 3300               | 1800                   |
| 34            | 3400                                     | 3500               | 1850                   |

#### 2.0 Extension of Voltage Grades

This report is applicable to other voltage grades when supply has been agreed by \$ales/Production.

#### 3.0 De-rating Factor

A blocking voltage de-rating factor of 0.13%/°C is applicable to this device for T<sub>i</sub> below 25°C.

#### 4.0 Snubber Components

When selecting snubber components, care must be taken not to use excessively large values of snubber capacitor or excessively small values of snubber resistor. Such excessive component values may lead to device damage due to the large resultant values of snubber discharge current. If required, please consult the factory for assistance.

#### 5.0 Computer Modelling Parameters

5.1 Device Dissipation Calculations

$$I_{AV} = \frac{-V_{T0} + \sqrt{{V_{T0}}^2 + 4 \cdot f\!f^2 \cdot r_T \cdot W_{AV}}}{2 \cdot f\!f^2 \cdot r_T} \qquad \text{and:}$$

$$W_{AV} = \frac{\Delta T}{R_{th}}$$
$$\Delta T = T_{j \max} - T_{K}$$

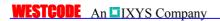
Where  $V_{T0}$ =0.86V,  $r_T$ =0.115m $\Omega$ ,

 $R_{\it th}$  = Supplementary thermal impedance, see table below and

ff = Form factor, see table below.

| \$upplementary Thermal Impedance |               |                |               |        |  |  |
|----------------------------------|---------------|----------------|---------------|--------|--|--|
| Conduction Angle                 | 6 phase (60°) | 3 phase (120°) | ½ wave (180°) | d.c.   |  |  |
| Square wave Double Side Cooled   | 0.0205        | 0.0190         | 0.0170        | 0.0160 |  |  |
| Square wave Single Side Cooled   | 0.0400        | 0.0376         | 0.0340        | 0.0320 |  |  |
| Sine wave Double Side Cooled     | 0.0198        | 0.0177         | 0.0162        |        |  |  |
| Sine wave Single Side Cooled     | 0.0388        | 0.0355         | 0.0324        |        |  |  |

| Form Factors               |  |       |       |   |  |  |
|----------------------------|--|-------|-------|---|--|--|
| Conduction Angle           | Conduction Angle 6 phase (60°) 3 phase (120°) ½ wave (180°) d.c. |       |       |   |  |  |
| Square wave                | 2.449  | 1.732 | 1.414 | 1 |  |  |
| Sine-wave 2.778 1.879 1.57 |  |       |       |   |  |  |



#### 5.2 Calculating V<sub>F</sub> using ABCD Coefficients

The on-state characteristic I<sub>F</sub> vs. V<sub>F</sub>, on page 6 is represented in two ways;

- (i) the well established  $V_{T0}$  and  $r_T$  tangent used for rating purposes and
- (ii) a set of constants A, B, C, D, forming the coefficients of the representative equation for  $V_F$  in terms of  $I_F$  given below:

$$V_F = A + B \cdot \ln(I_F) + C \cdot I_F + D \cdot \sqrt{I_F}$$

The constants, derived by curve fitting software, are given below for both hot and cold characteristics. The resulting values for  $V_F$  agree with the true device characteristic over a current range, which is limited to that plotted.

|   |                           | 4                  |                           |  |
|---|---------------------------|--------------------|---------------------------|--|
|   | 25°C Coefficients         | 175°C Coefficients |                           |  |
| Α | 0.7415911                 | Α                  | 0.4271823                 |  |
| В | 0.01014829                | В                  | 0.02992417                |  |
| С | 5.11423×10 <sup>-5</sup>  | /C_                | 8.05316×10 <sup>-5</sup>  |  |
| D | 4.822900×10 <sup>-3</sup> | ( b /              | 5.160430×10 <sup>-3</sup> |  |





#### 5.3 D.C. Thermal Impedance Calculation

$$r_t = \sum_{p=1}^{p=n} r_p \cdot \left(1 - e^{\frac{-t}{\tau_p}}\right)$$



Where p = 1 to n, n is the number of terms in the series and:

t = Duration of heating pulse in seconds.

r, = Thermal resistance at time t.

 $r_p$  = Amplitude of  $p_{th}$  term.

 $\tau_p$  = Time Constant of  $r_{th}$  term.

The coefficients for this device are shown in the tables below:

| D.C. Double Side Cooled        |                           |                           |                           |                           |  |  |  |
|--------------------------------|---------------------------|---------------------------|---------------------------|---------------------------|--|--|--|
| Term                           | 1                         | 2                         | 3                         | 4                         |  |  |  |
| $r_p$                          | 6.850949×10 <sup>-3</sup> | 6.006273×10 <sup>-3</sup> | 1.872869×10 <sup>-3</sup> | 1.385196×10 <sup>-3</sup> |  |  |  |
| $	au_{\!\scriptscriptstyle D}$ | 1.219991                  | 0.1764593                 | 0.02313936                | 3.319288×10 <sup>-3</sup> |  |  |  |
|                                |                           |                           |                           |                           |  |  |  |

|           |                         |                             |                           | \                         |                           |  |  |  |
|-----------|-------------------------|-----------------------------|---------------------------|---------------------------|---------------------------|--|--|--|
|           | D.C. Single Side Cooled |                             |                           |                           |                           |  |  |  |
| Term      | 1                       | 2                           | 3                         | 4                         | 5                         |  |  |  |
| $r_p$     | 0.01803063              | 5.201877×10 <sup>-3</sup> / | 4.810704×10 <sup>-3</sup> | 3.890524×10 <sup>-3</sup> | 2.299757×10 <sup>-3</sup> |  |  |  |
| $	au_{p}$ | 9.810556                | 4.974419                    | 0.3591421                 | 0.09925002                | 5.541104×10 <sup>-3</sup> |  |  |  |

#### 6.0 Reverse recovery ratings

(i) Q<sub>ra</sub> is based on 50% I<sub>rm</sub> chord as shown in Fig. 1



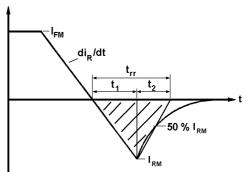
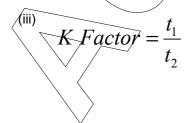


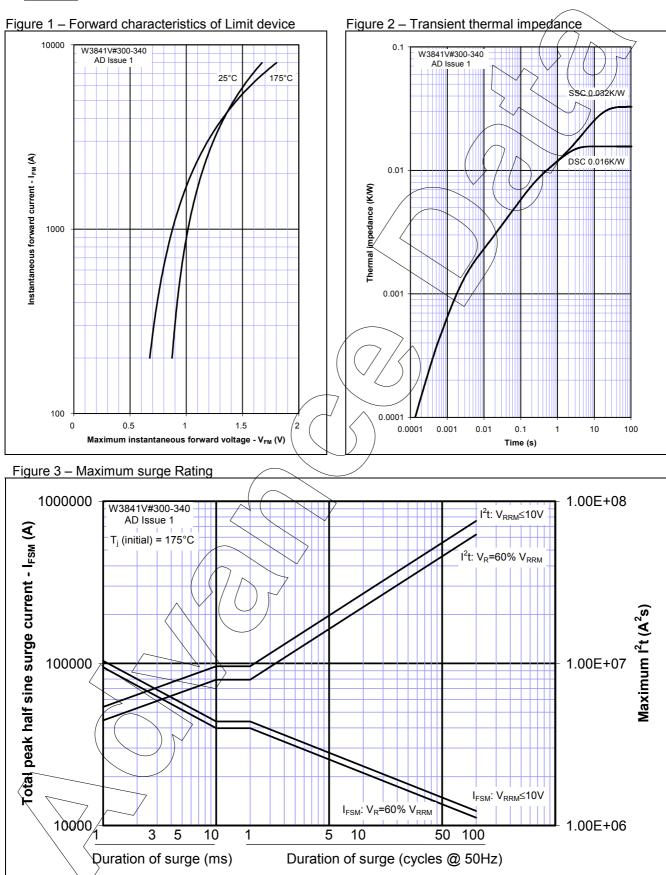
Fig. 1

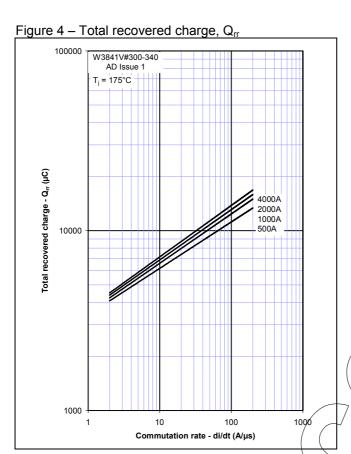
(ii) Q<sub>rr</sub> is based on a 150 µs integration time i.e.

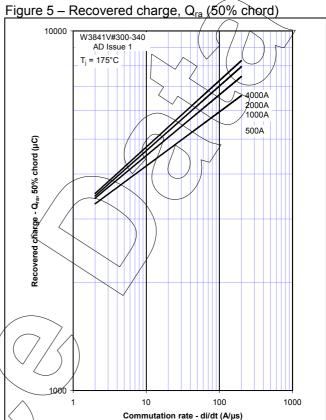
$$Q_{rr} = \int_{0}^{150 \, \mu s} i_{rr}.dt$$

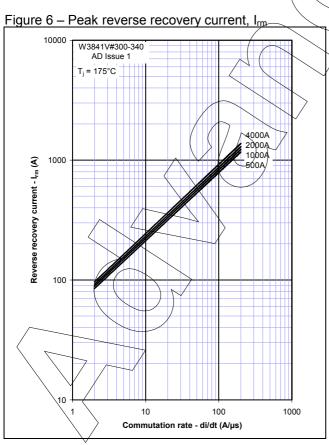


#### **Curves**









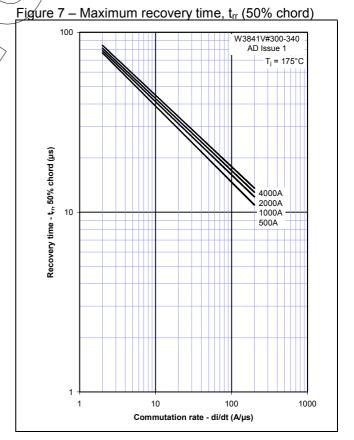


Figure 8 – Forward current vs. Power dissipation – Double Side Cooled

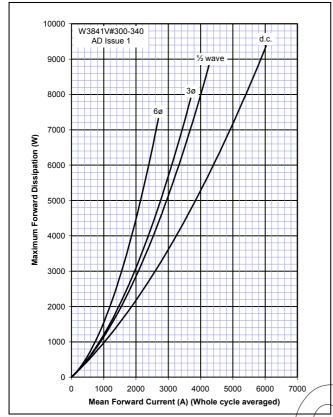


Figure 10 – Forward current vs. Power dissipation – Single Side Cooled

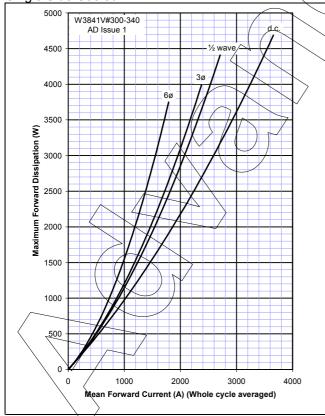


Figure 9 – Forward current vs. Heatsink temperature – Double Side Cooled

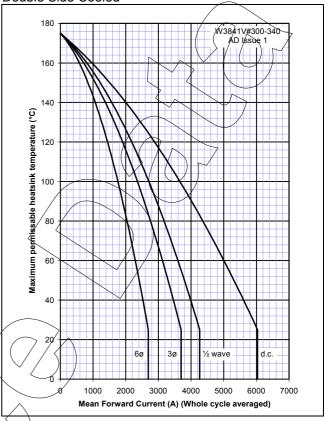
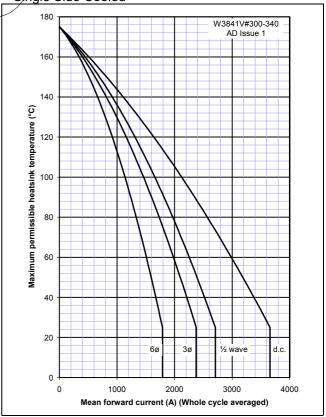
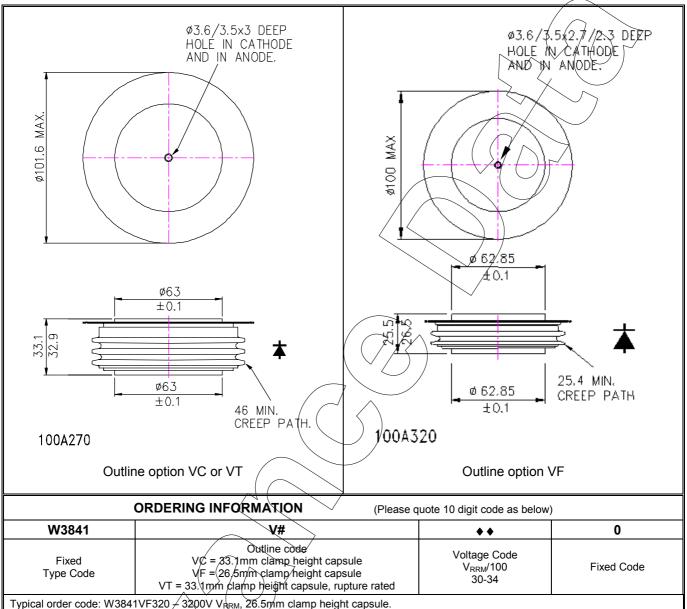


Figure 11 – Forward current vs. Heatsink temperature – Single Side Cooled



#### **Outline Drawing & Ordering Information**



#### **IXYS Semiconductor GmbH**

Edisonstraße 15 D-68623 Lampertheim Tel: +49 6206 503-0 Fax: +49 6206 503-627

E-mail: marcom@ixys.de

#### **IXYS** Corporation

3540 Bassett Street Santa Clara CA 95054 USA Tel: +1 (408) 982 0700

Fax: +1 (408) 496 0670 E-mail: sales@ixys.net

An IXYS Company

www.westcode.com

www.ixvs.com

#### **Westcode Semiconductors Ltd**

Langley Park Way, Langley Park, Chippenham, Wiltshire, SN15 1GE. Tel: +44 (0)1249 444524 Fax: +44 (0)1249 659448

E-mail: WSL.sales@westcode.com

#### **Westcode Semiconductors Inc**

3270 Cherry Avenue Long Beach CA 90807 USA Tel: +1 (562) 595 6971 Fax: +1 (562) 595 8182

E-mail: WSI.sales@westcode.com

The information coordined herein is confidential and is protected by Copyright. The information may not be used or disclosed except with the written permission of and in the manner permitted by the proprietors Westcode Semiconductors Ltd.

In the interest of product improvement, Westcode reserves the right to change specifications at any time without prior notice.

Devices with a suffix code/(2-letter, 3-letter or letter/digit/letter combination) added to their generic code are not necessarily subject to the conditions and limits contained in this report.

© Westcode Semiconductors Ltd.